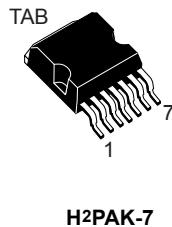


## Silicon carbide Power MOSFET 650 V, 55 mΩ typ., 45 A in an H<sup>2</sup>PAK-7 package



### Features

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	I <sub>D</sub>
SCTH35N65G2V-7	650 V	67 mΩ	45 A

- Very fast and robust intrinsic body diode
- Extremely low gate charge and input capacitance
- Source sensing pin for increased efficiency

### Applications

- Switching mode power supply
- DC-DC converters
- Industrial motor control

### Description

This silicon carbide Power MOSFET device has been developed using ST's advanced and innovative 2<sup>nd</sup> generation SiC MOSFET technology. The device features remarkably low on-resistance per unit area and very good switching performance. The variation of switching loss is almost independent of junction temperature.



#### Product status link

[SCTH35N65G2V-7](#)

#### Product summary

Order code	SCTH35N65G2V-7
Marking	SCT35N65
Package	H <sup>2</sup> PAK-7
Packing	Tape and reel

## 1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-source voltage	650	V
$V_{GS}$	Gate-source voltage	-10 to 22	V
	Gate-source voltage (recommended operating range)	-5 to 18	
$I_D$	Drain current (continuous) at $T_C = 25^\circ\text{C}$	45	A
	Drain current (continuous) at $T_C = 100^\circ\text{C}$	35	
$I_{DM}^{(1)}$	Drain current (pulsed)	90	A
$P_{TOT}$	Total power dissipation at $T_C = 25^\circ\text{C}$	208	W
$T_{stg}$	Storage temperature range	-55 to 175	$^\circ\text{C}$
$T_J$	Operating junction temperature range		$^\circ\text{C}$

1. Pulse width is limited by safe operating area.

Table 2. Thermal data

Symbol	Parameter	Value	Unit
$R_{thJC}$	Thermal resistance, junction-to-case	0.72	$^\circ\text{C}/\text{W}$
$R_{thJA}$	Thermal resistance, junction-to-ambient	62.5	$^\circ\text{C}/\text{W}$

## 2 Electrical characteristics

( $T_C = 25^\circ\text{C}$  unless otherwise specified)

**Table 3. On/off states**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(\text{BR})\text{DSS}}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	650			V
$I_{\text{DSS}}$	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 650 \text{ V}$			5	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = -10 \text{ to } 22 \text{ V}$			$\pm 100$	nA
$V_{GS(\text{th})}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 1 \text{ mA}$	1.8	3.2	5	V
$R_{\text{DS(on)}}$	Static drain-source on-resistance	$V_{GS} = 20 \text{ V}, I_D = 20 \text{ A}$		45	67	$\text{m}\Omega$
		$V_{GS} = 18 \text{ V}, I_D = 20 \text{ A}$		55		
		$V_{GS} = 20 \text{ V}, I_D = 20 \text{ A}, T_J = 175^\circ\text{C}$		65		

**Table 4. Dynamic, based on HiP247 package option**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$C_{iss}$	Input capacitance	$V_{DS} = 400 \text{ V}, f = 1 \text{ MHz}, V_{GS} = 0 \text{ V}$	-	1370	-	pF
$C_{oss}$	Output capacitance		-	125	-	pF
$C_{rss}$	Reverse transfer capacitance		-	30	-	pF
$Q_g$	Total gate charge	$V_{DD} = 400 \text{ V}, V_{GS} = 0 \text{ to } 20 \text{ V}, I_D = 20 \text{ A}$	-	73	-	nC
$Q_{gs}$	Gate-source charge		-	14	-	nC
$Q_{gd}$	Gate-drain charge		-	27	-	nC
$R_g$	Gate input resistance	$f = 1 \text{ MHz}, I_D = 0 \text{ A}$	-	2	-	$\Omega$

**Table 5. Switching energy (inductive load), based on HiP247 package option**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$E_{\text{on}}$	Turn-on switching energy	$V_{DD} = 400 \text{ V}, I_D = 20 \text{ A}$	-	100	-	$\mu\text{J}$
$E_{\text{off}}$	Turn-off switching energy		-	35	-	$\mu\text{J}$

**Table 6. Switching times, based on HiP247 package option**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(\text{on})}$	Turn-on delay time	$V_{DD} = 400 \text{ V}, I_D = 20 \text{ A}, R_G = 4.7 \Omega, V_{GS} = -5 \text{ to } 20 \text{ V}$	-	16	-	ns
$t_f$	Fall time		-	14	-	
$t_{d(\text{off})}$	Turn-off delay time		-	35	-	
$t_r$	Rise time		-	9	-	

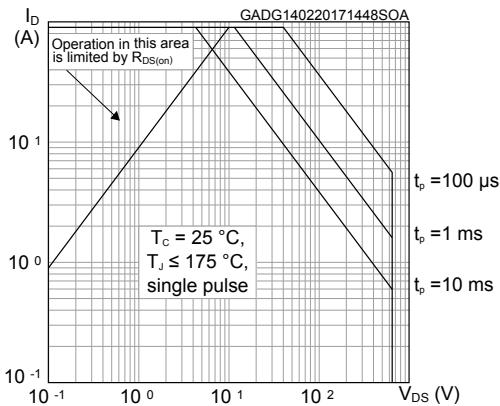
**Table 7. Reverse SiC diode characteristics**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V <sub>SD</sub>	Diode forward voltage	I <sub>F</sub> = 20 A, V <sub>GS</sub> = 0 V V <sub>DD</sub> = 400 V, I <sub>F</sub> = 20 A, di/dt = 1000 A/μs	-	3.3	-	V
t <sub>rr</sub>	Reverse recovery time		-	18	-	ns
Q <sub>rr</sub>	Reverse recovery charge		-	85	-	nC
I <sub>RRM</sub>	Reverse recovery current		-	7	-	A

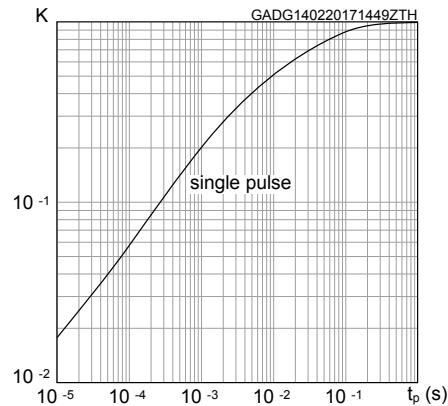
## 2.1

## Electrical characteristics (curves), based on HiP247 package option

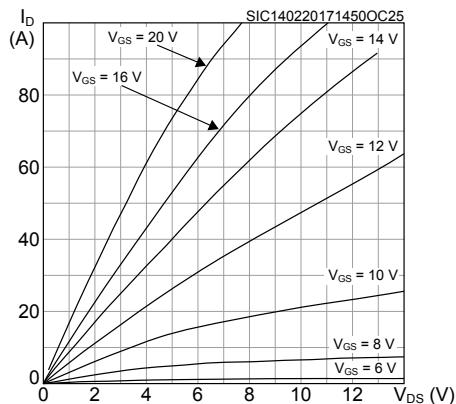
**Figure 1. Safe operating area**



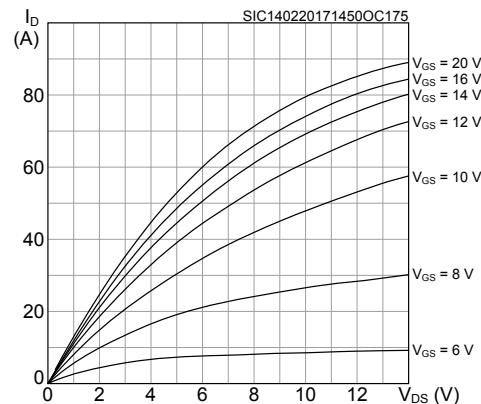
**Figure 2. Thermal impedance**



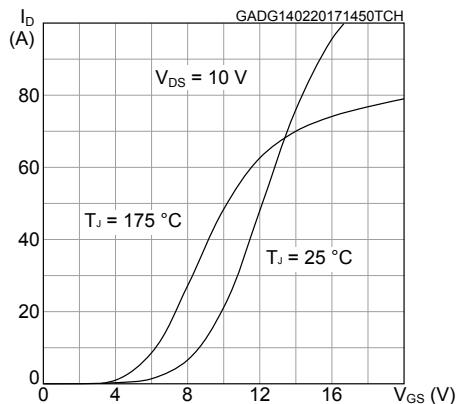
**Figure 3. Output characteristics ( $T_j = 25^\circ C$ )**



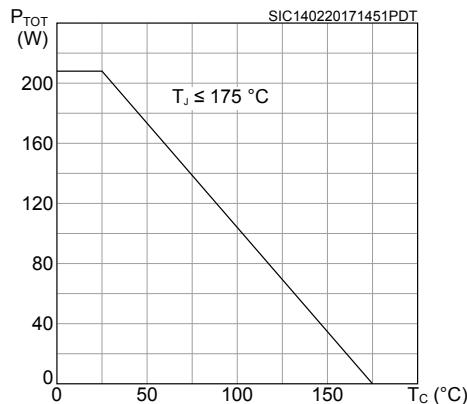
**Figure 4. Output characteristics ( $T_j = 175^\circ C$ )**



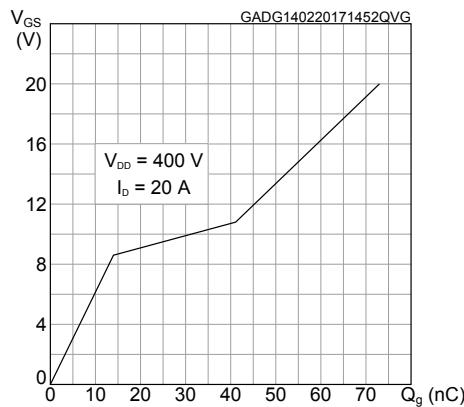
**Figure 5. Transfer characteristics**



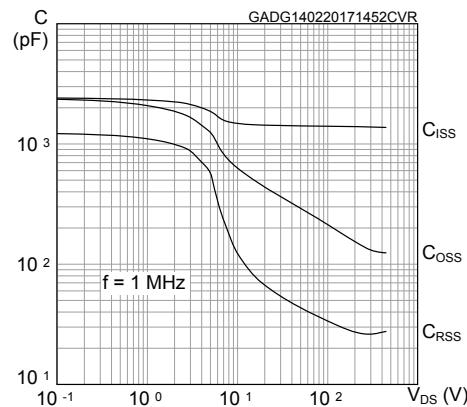
**Figure 6. Total power dissipation**



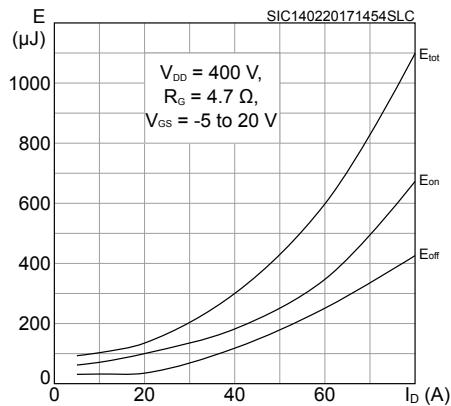
**Figure 7. Gate charge vs gate-source voltage**



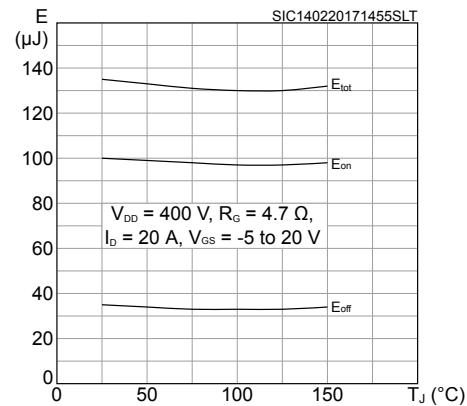
**Figure 8. Capacitance variations**



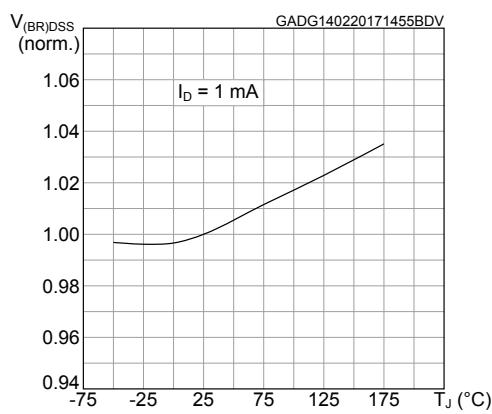
**Figure 9. Switching energy vs. drain current**



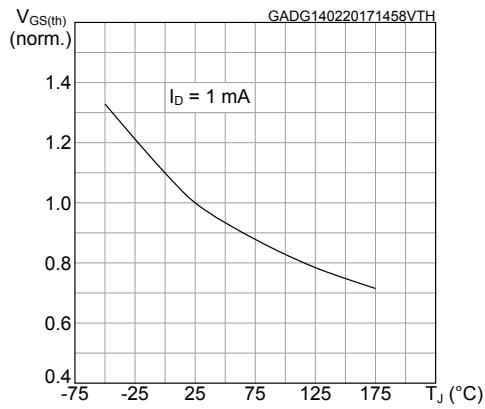
**Figure 10. Switching energy vs. junction temperature**



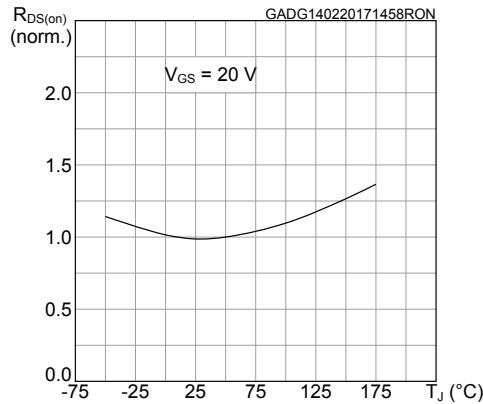
**Figure 11. Normalized  $V_{(BR)DSS}$  vs. temperature**



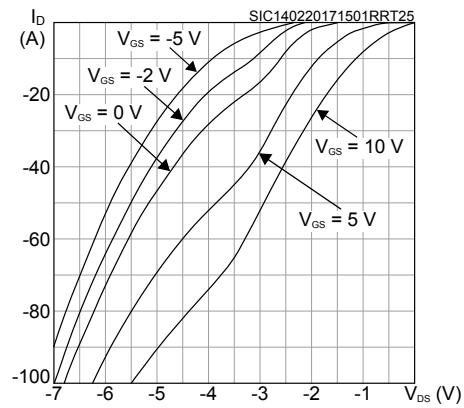
**Figure 12. Normalized gate threshold voltage vs. temperature**



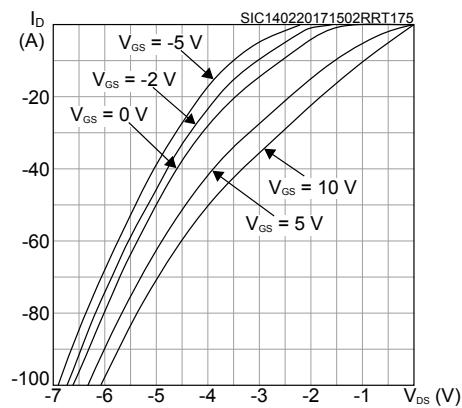
**Figure 13. Normalized on-resistance vs. temperature**



**Figure 14. Reverse conduction characteristics ( $T_J = 25$  °C)**

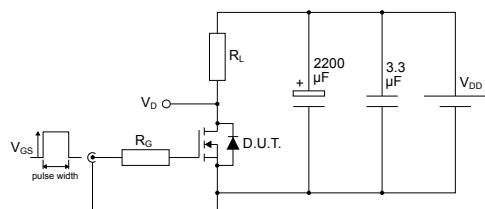


**Figure 15. Reverse conduction characteristics ( $T_J = 175$  °C)**



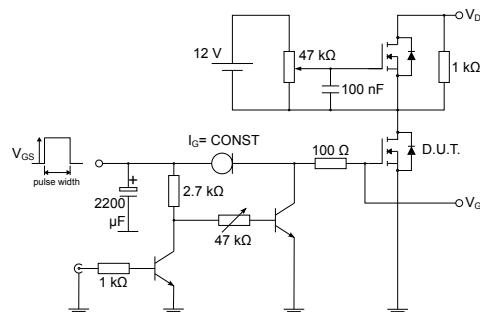
### 3 Test circuits

**Figure 16.** Test circuit for resistive load switching times



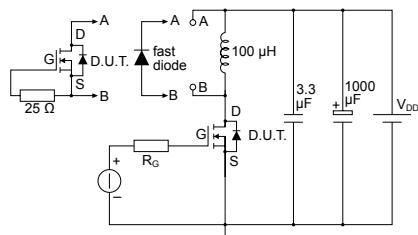
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**Figure 17.** Test circuit for gate charge behavior



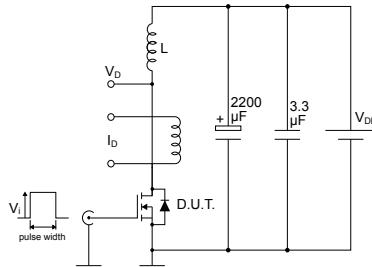
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**Figure 18.** Test circuit for inductive load switching and diode recovery times



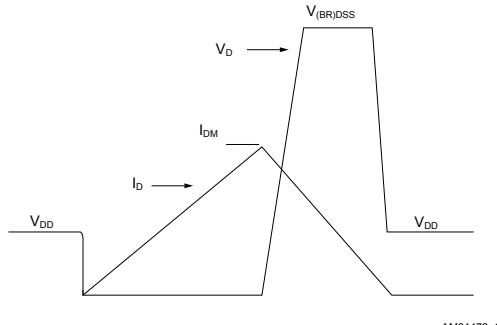
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**Figure 19.** Unclamped inductive load test circuit



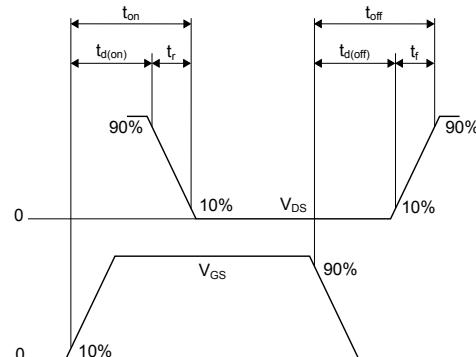
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**Figure 20.** Unclamped inductive waveform



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**Figure 21.** Switching time waveform



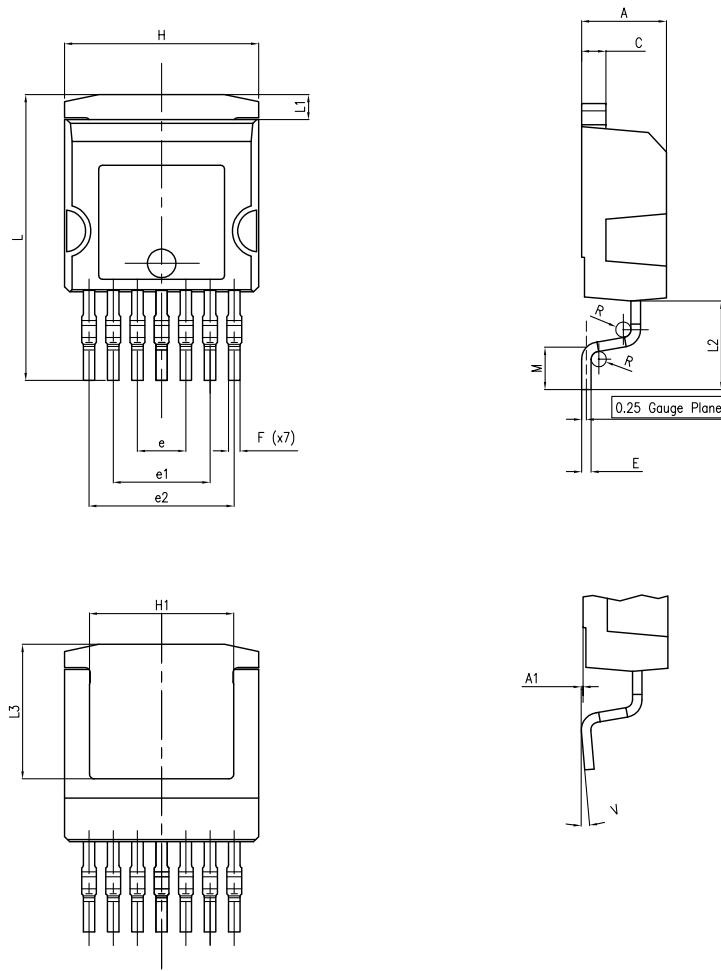
AM01473v1

## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

### 4.1 H<sup>2</sup>PAK-7 package information

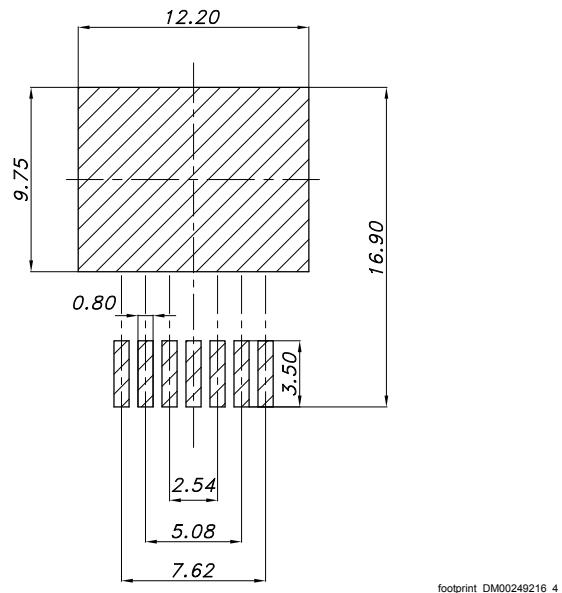
Figure 22. H<sup>2</sup>PAK-7 package outline



DM00249216\_4

Table 8. H<sup>2</sup>PAK-7 package mechanical data

Dim.	mm	
	Min.	Max.
A	4.30	4.80
A1	0.03	0.20
C	1.17	1.37
e	2.34	2.74
e1	4.88	5.28
e2	7.42	7.82
E	0.45	0.60
F	0.50	0.70
H	10.00	10.40
H1	7.40	7.60
L	14.75	15.25
L1	1.27	1.40
L2	4.35	4.95
L3	6.85	7.25
M	1.90	2.50
R	0.20	0.60
V	0°	8°

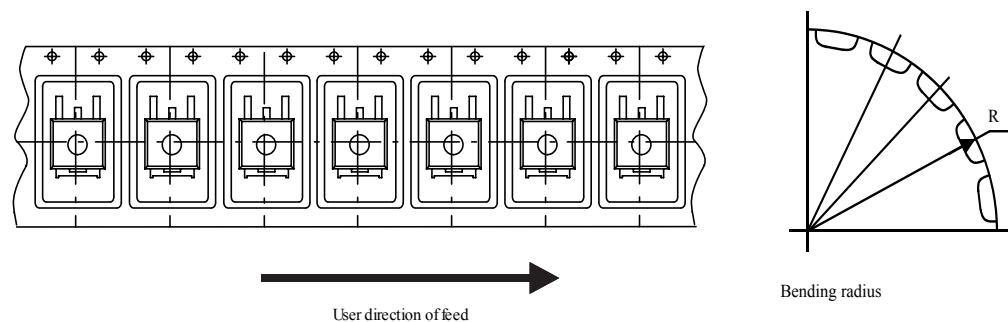
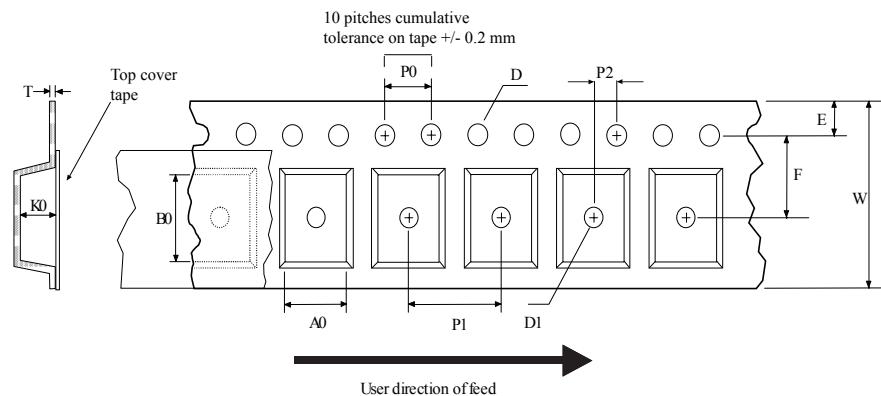
Figure 23. H<sup>2</sup>PAK-7 recommended footprint

footprint\_DM00249216\_4

Note: Dimensions are in mm.

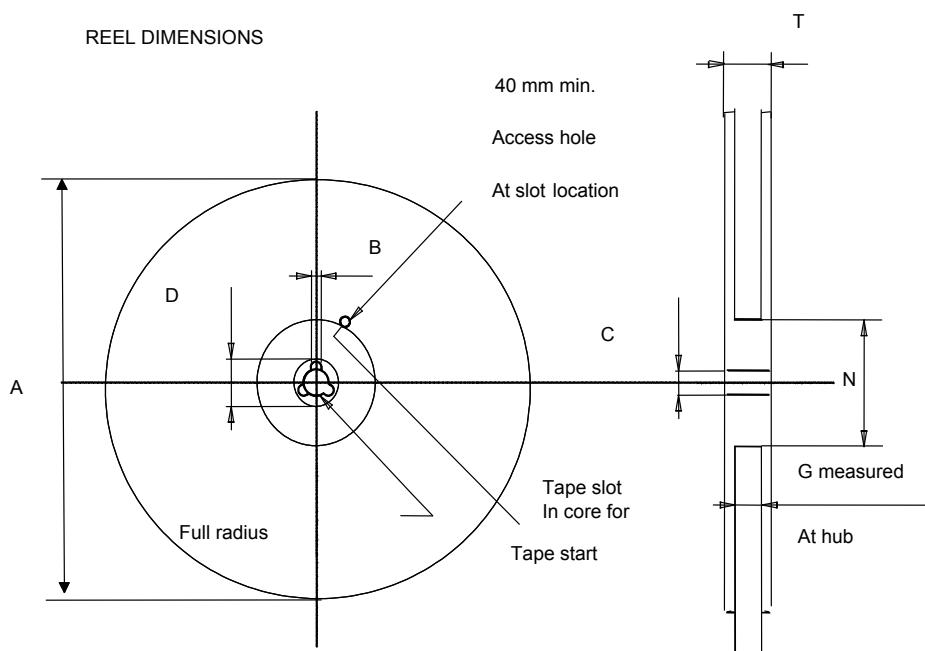
## 4.2 Packing information

**Figure 24. Tape outline**



AM08852v2

**Figure 25. Reel outline**



**Table 9. Tape and reel mechanical data**

Tape			Reel		
Dim.	mm		Dim.	mm	
	Min.	Max.		Min.	Max.
A0	10.5	10.7	A		330
B0	15.7	15.9	B	1.5	
D	1.5	1.6	C	12.8	13.2
D1	1.59	1.61	D	20.2	
E	1.65	1.85	G	24.4	26.4
F	11.4	11.6	N	100	
K0	4.8	5.0	T		30.4
P0	3.9	4.1			
P1	11.9	12.1		Base quantity	1000
P2	1.9	2.1		Bulk quantity	1000
R	50				
T	0.25	0.35			
W	23.7	24.3			

## Revision history

**Table 10. Document revision history**

Date	Revision	Changes
27-Feb-2017	1	First release.
12-Dec-2017	2	Modified title. Modified <a href="#">Table 4: "On/off states"</a> . Minor text changes.
03-Oct-2019	3	Updated title, Features and Description in cover page. Minor text changes.
09-Jan-2020	4	Updated <a href="#">Table 1. Absolute maximum ratings</a> . Minor text changes.
17-Dec-2020	5	Updated <a href="#">Table 7. Reverse SiC diode characteristics</a> . Minor text changes.

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